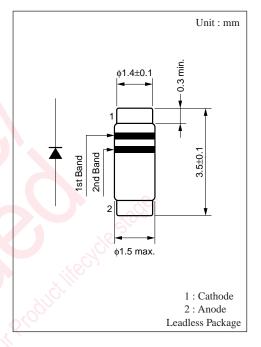
# **MA782**

### Silicon epitaxial planer type

For super high-speed switching circuit For small current rectification

#### Features

- Sealed in the LLD package, enabling high-density mounting
- $I_{F(AV)} = 200 \text{mA}$  rectification possible
- Reverse voltage  $V_R$  (DC value) = 40V guaranteed



#### Absolute Maximum Ratings ( $Ta = 25^{\circ}C$ )

Parameter	Symbol	Rating	Unit	
Reverse voltage (DC)	VR	40	V	
Repetitive peak reverse voltage	V <sub>RRM</sub>	40	V	
Peak forward current	I <sub>FM</sub>	300	mA	
Average forward current	I <sub>F(AV)</sub>	200	mA	
Non-repetitive peak forward surge current	I <sub>FSM</sub> *	1.5	A	
Junction temperature	Tj	150	°C	
Storage temperature	T <sub>stg</sub>	– <mark>55</mark> to +150	°C	

\* 50Hz sine wave, one-cycle wave, high value (non-repetitive)

#### ■ Electrical Characteristics (Ta= 25°C)

Parameter	Symbol	Condition	min	typ	max	Unit
Reverse current (DC)	S I <sub>R</sub>	V <sub>R</sub> =40V			15	μΑ
Forward voltage (DC)	VF	I <sub>F</sub> = 200mA			0.55	V
Terminal capacitance	Ct	$V_R = 0V$ , f=1MHz		30		pF
Reverse recovery time t <sub>rr</sub> *	$I_F = I_R = 100 \text{mA}$		3		ns	
	$I_{rr} = 10 \text{mA}$ , $R_L = 100 \Omega$					

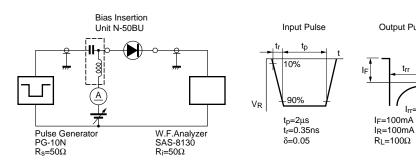
Note 1. Schottky barrier diode is sensitive to electric shock (static electricity, etc.). Due attention must be paid on charge of a human body and leakage from the equipment used.

Output Pulse

Irr=10mA

2. Rated input/output frequency : 1000MHz

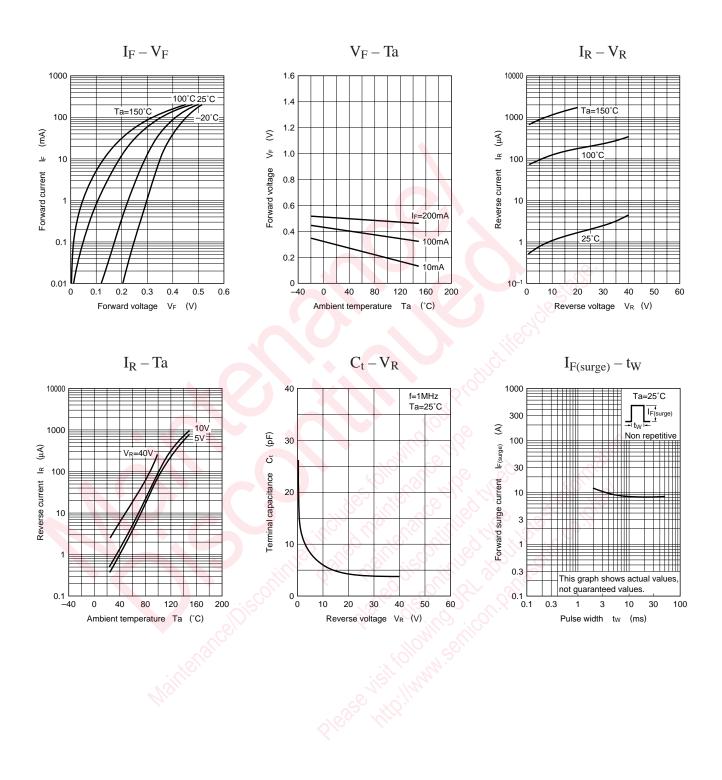
3. \* t<sub>rr</sub> measuring circuit



#### Cathode Indication

Type No.		MA782		
Color	1st Band	Pink		
	2nd Band	Yellow		





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